CMOS Digital Integrated Circuits Silicon Monolithic

# 74HC393D

#### 1. Functional Description

• Dual Binary Counter

#### 2. General

The 74HC393D is a high speed CMOS 4-BIT BINARY COUNTER fabricated with silicon gate C<sup>2</sup>MOS technology. It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

It contains two independent counter circuits in one package, so that counting or frequency division of eight binary bits can be achieved with one IC.

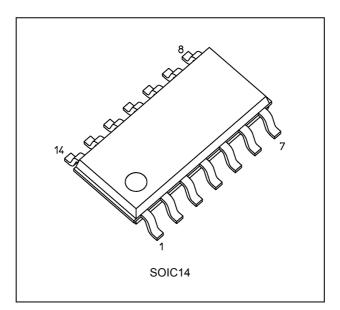
This device changes state on the negative going transition of the  $\overline{CK}$  pulse. The counter can be reset to "0" (QA to QD = "L") by a high at the CLR input regardless of other inputs.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

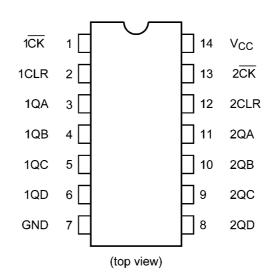
#### 3. Features

- (1) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C (Note 1)
- (2) High speed:  $f_{MAX}$  = 72 MHz (typ.) at V<sub>CC</sub> = 5 V
- (3) Low power dissipation:  $I_{CC} = 4.0 \ \mu A \ (max)$  at  $T_a = 25 \ ^{\circ}C$
- (4) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (5) Wide operating voltage range:  $V_{CC(opr)} = 2.0 \text{ V to } 6.0 \text{ V}$
- Note 1: Operating Range spec of  $T_{opr} = -40$  °C to 125 °C is applicable only for the products which manufactured after July 2020.

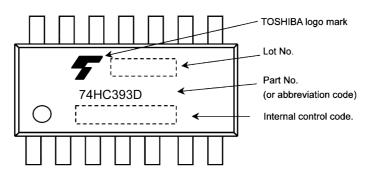
#### 4. Packaging



#### 5. Pin Assignment



#### 6. Marking



#### 7. IEC Logic Symbol

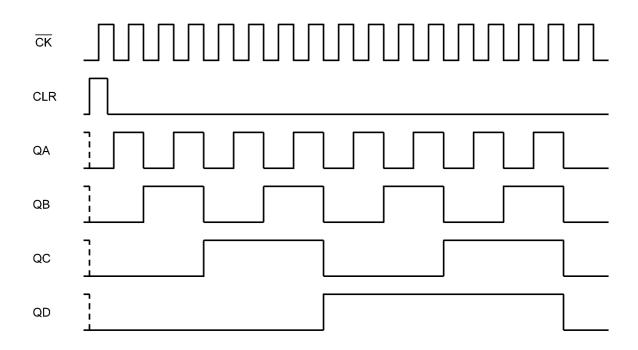
1CLR <u>(2)</u> 1 <del>CK</del> <u>(1)</u> ►	CTRDIV 16  CT = 0  CT  +  CT  3	(3) 1QA (4) 1QB (5) 1QC (6) 1QD
2CLR <u>(12)</u> 2 <del>CK (13) </del>		(11) 2QA (10) 2QB (9) 2QC (8) 2QC
		2QD

#### 8. Truth Table

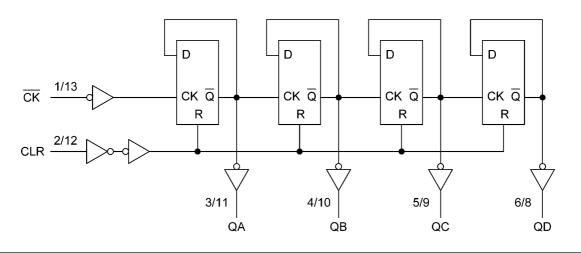
Inp	outs		Out	puts	
СК	CLR	QA	QD		
Х	Н	L	L	L	L
	L		Cou	nt up	
	L		No ch	nange	

X: Don't care

#### 9. Timing Diagrams



#### 10. System Diagram



#### 11. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		±20	mA
Output diode current	I <sub>ОК</sub>		±20	mA
Output current	I <sub>OUT</sub>		±25	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	mA
Power dissipation	PD	(Note 1)	500	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: P<sub>D</sub> derates linearly with -8 mW/°C above 85 °C

#### 12. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>	—		2.0 to 6.0	V
Input voltage	V <sub>IN</sub>	—		0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	—		0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	—	(Note 1)	-40 to 125	°C
Input rise and fall times	t <sub>r</sub> ,t <sub>f</sub>	V <sub>CC</sub> = 2.0 V		0 to 1000	ns
		V <sub>CC</sub> = 4.5 V		0 to 500	
		V <sub>CC</sub> = 6.0 V		0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device.

Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 1: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

#### **13. Electrical Characteristics**

#### 13.1. DC Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Test Conditio	n	V <sub>CC</sub> (V)	Min	Тур.	Мах	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	1
				6.0	4.20	_	_	1
Low-level input voltage	VIL	_	—		_	_	0.50	V
				4.5	_	_	1.35	1
				6.0	_	_	1.80	]
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5	_	]
				6.0	5.9	6.0	_	]
			I <sub>OH</sub> = -4 mA	4.5	4.18	4.31	_	]
			I <sub>OH</sub> = -5.2 mA	6.0	5.68	5.80	—	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	2.0	_	0.0	0.1	V
				4.5		0.0	0.1	]
				6.0	_	0.0	0.1	
			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	]
			I <sub>OL</sub> = 5.2 mA	6.0	_	0.18	0.26	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GNE	)	6.0	_	_	±0.1	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GNE	)	6.0			4.0	μA

#### 13.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Cond	lition	V <sub>CC</sub> (V)	Min	Мах	Unit
High-level input voltage	V <sub>IH</sub>	—		2.0	1.50	—	V
				4.5	3.15	_	
				6.0	4.20	_	
Low-level input voltage	VIL	_		2.0	_	0.50	V
				4.5		1.35	
				6.0	_	1.80	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA	2.0	1.9	—	V
				4.5	4.4	—	
				6.0	5.9	—	
			I <sub>OH</sub> = -4 mA	4.5	4.13	—	
			I <sub>OH</sub> = -5.2 mA	6.0	5.63	—	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	2.0		0.1	V
				4.5		0.1	
				6.0	_	0.1	
			I <sub>OL</sub> = 4 mA	4.5	_	0.33	
			I <sub>OL</sub> = 5.2 mA	6.0	_	0.33	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0		40.0	μA

### 13.3. DC Characteristics (Note) (Unless otherwise specified, $T_a$ = -40 to 125 °C)

Characteristics	Symbol	Test Cond	dition	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	VIH	_		2.0	1.50	_	V
				4.5	3.15	_	
				6.0	4.20	_	1
Low-level input voltage	VIL	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80	1
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	1
			I <sub>OH</sub> = -4 mA	4.5	3.7	_	
			I <sub>OH</sub> = -5.2 mA	6.0	5.2	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 20 μA	2.0	_	0.1	V
				4.5	_	0.1	1
				6.0	_	0.1	
			I <sub>OL</sub> = 4 mA	4.5	_	0.4	1
			I <sub>OL</sub> = 5.2 mA	6.0	_	0.4	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	_	80.0	μΑ

Note: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

## 13.4. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Unit
M <u>ini</u> mum pulse width	$t_{w(L)}, t_{w(H)}$	_	2.0		75	ns
			4.5		15	
			6.0	_	13	
Minimum pulse width (CLR)	t <sub>w(H)</sub>	—	2.0	_	75	ns
			4.5		15	
			6.0	_	13	
Minimum removal time	t <sub>rem</sub>	_	2.0	_	25	ns
			4.5	_	5	
			6.0	_	5	
Clock frequency	f	_	2.0	_	6	MHz
			4.5	_	32	
			6.0	_	38	

#### 13.5. Timing Requirements (Unless otherwise specified, T<sub>a</sub> = -40 to 85 ℃, Input: t<sub>r</sub> = t<sub>f</sub> = 6 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width	t <sub>w(L)</sub> ,t <sub>w(H)</sub>		2.0	95	ns
(CK)			4.5	19	
			6.0	16	
Minimum pulse width	t <sub>w(H)</sub>	_	2.0	95	ns
(CLR)			4.5	19	
			6.0	16	
Minimum removal time	t <sub>rem</sub>		2.0	30	ns
			4.5	6	
			6.0	5	
Clock frequency	f		2.0	5	MHz
			4.5	27	
			6.0	32	

#### 13.6. Timing Requirements (Note) (Unless otherwise specified, T<sub>a</sub> = -40 to 125 °C, Input: t<sub>r</sub> = t<sub>f</sub> = 6 ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width ( $\overline{CK}$ )	$t_{w(L)}, t_{w(H)}$	—	2.0	110	ns
			4.5	22	
			6.0	18	
Minimum pulse width (CLR)	t <sub>w(H)</sub>	_	2.0	110	ns
			4.5	22	
			6.0	18	
Minimum removal time	t <sub>rem</sub>	_	2.0	35	ns
			4.5	7	
			6.0	5	
Clock frequency	f		2.0	5	MHz
			4.5	24	]
			6.0	28	

Note: Operating Range spec of T<sub>opr</sub> = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.

# 13.7. AC Characteristics (Unless otherwise specified, $C_L$ = 15 pF, $V_{CC}$ = 5 V, $T_a$ = 25 °C, Input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>		—	—	4	8	ns
P <u>rop</u> agation delay time (CK-QA)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	—	12	20	ns
Propagation delay time (CK-QB)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	—	16	31	ns
Propagation delay time (CK-QC)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	—	21	38	ns
Propagation delay time (CK-QD)	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	—	25	46	ns
Propagation delay time (CLR-Qn)	t <sub>PHL</sub>		_	_	15	26	ns
Maximum clock frequency	f <sub>MAX</sub>		—	35	72	_	MHz

#### 13.8. AC Characteristics (Unless otherwise specified, C<sub>L</sub> = 50 pF, T<sub>a</sub> = 25 °C, Input: t<sub>r</sub> = t<sub>f</sub> = 6 ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>		_	2.0	_	25	75	ns
				4.5		7	15	1
				6.0	_	6	13	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		—	2.0	—	45	120	ns
(CK-QA)				4.5		15	24	
				6.0	—	13	20	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	2.0	—	60	180	ns
(CK-QB)				4.5	—	20	36	
				6.0	—	17	31	
P <u>rop</u> agation delay time (CK-QC)	t <sub>PLH</sub> ,t <sub>PHL</sub>		—	2.0	_	80	220	ns
				4.5	—	25	44	
				6.0	—	21	37	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		—	2.0		100	260	ns
(CK-QD)				4.5		30	52	
				6.0	—	26	44	
Propagation delay time	t <sub>PHL</sub>		_	2.0	_	55	150	ns
(CLR-Qn)				4.5	—	18	30	1
				6.0	—	15	26	
Maximum clock frequency	f <sub>MAX</sub>		_	2.0	6	22	_	MHz
				4.5	32	67	—	
				6.0	38	77	_	
Input capacitance	C <sub>IN</sub>		_		_	5	10	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	_			40		pF

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/2$  (per circuit)

#### 13.9. AC Characteristics (Unless otherwise specified, $C_L = 50$ pF, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>	_	2.0	_	95	ns
			4.5	_	19	
			6.0	—	16	
Propagation delay time (CK-QA)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	_	150	ns
			4.5	_	30	
			6.0	_	26	
Propagation delay time (CK-QB)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	_	225	ns
			4.5	_	45	]
			6.0	—	38	
P <u>rop</u> agation delay time (CK-QC)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	—	275	ns
			4.5	_	55	
			6.0	—	47	
P <u>rop</u> agation delay time (CK-QD)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	—	325	ns
			4.5		65	-
			6.0	_	55	
Propagation delay time (CLR-Qn)	t <sub>PHL</sub>	_	2.0	—	190	ns
			4.5	—	38	
			6.0	—	33	
Maximum clock frequency	f <sub>MAX</sub>		2.0	5	—	MHz
			4.5	27	_	
			6.0	32	_	
Input capacitance	C <sub>IN</sub>			_	10	pF

## 13.10. AC Characteristics (Note) (Unless otherwise specified, $C_L$ = 50 pF, $T_a$ = -40 to 125 °C, Input: $t_r$ = $t_f$ = 6 ns)

•	•	- · ·		_		-
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>	—	2.0		110	ns
			4.5	_	22	
			6.0	_	18	ns
Propagation delay time (CK-QA)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	_	170	ns
			4.5	—	34	
			6.5		30	
Propagation delay time (CK-QB)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	_	255	ns
			4.5		51	
			6.0		43	
P <u>rop</u> agation delay time (CK-QC)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	—	315	ns
			4.5	_	63	
			6.0	_	54	
P <u>rop</u> agation delay time (CK-QD)	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	2.0	—	370	ns
			4.5	—	74	
			6.0	—	63	
Propagation delay time (CLR-Qn)	t <sub>PHL</sub>	_	2.0	—	220	ns
			4.5	—	44	
			6.0		38	
Maximum clock frequency	f <sub>MAX</sub>	_	2.0	4	_	MHz
			4.5	24	_	]
			6.0	28	_	
Input capacitance	C <sub>IN</sub>			_	10	pF

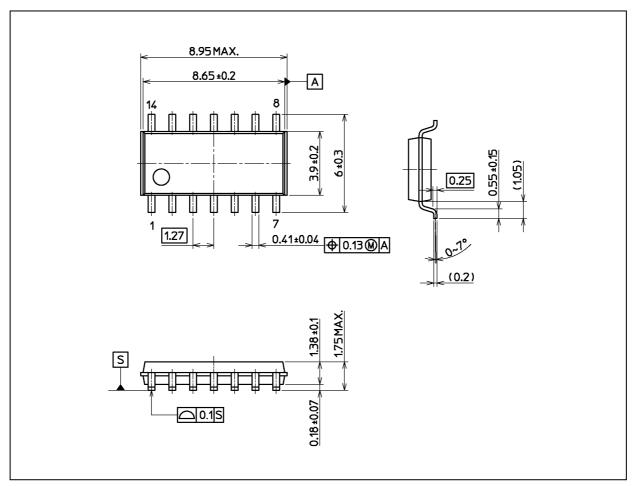
Note: Operating Range spec of  $T_{opr}$  = -40 °C to 125 °C is applicable only for the products which manufactured after July 2020.



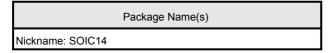
#### 74HC393D

#### Package Dimensions

Unit: mm



Weight: 0.13 g (typ.)



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 74VHC163FT(BJ)
 74HC393D.652
 74HCT4040D.653
 74HC191D.652
 74HC160D,652
 74HC390DB,118
 74HC163PW.112

 74HC191PW.112
 74HC393DB.118
 74HC4024D.652
 74HCT193DB.112
 74HCT390DB.112
 74HC193PW.112
 74HC390D.652

 74HC4017PW.112
 74HC4020DB.112
 74HC4020PW.112
 74HC4040DB.112
 74HC4060DB.112
 74HC4520D.112

 74HCT393DB.112
 74HC4020DB.112
 74HC4020PW.112
 74HC4060DB.112
 74HC4060DB.112
 74HC4520D.112

 74HCT393DB.112
 74HCT6323AD.112
 74LV393D.112
 74LV393PW.112
 74LV4060DB.112
 74LV4060PW.112

 74LVC161D.112
 74LVC161PW.112
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 XD74LS93
 CD4017BE
 XD74LS161
 XD74LS193
 CD4060BE
 XD4553

 XD74LS163
 XD74LS190
 XD40192
 CD4040BE
 XD4553
 XD4553